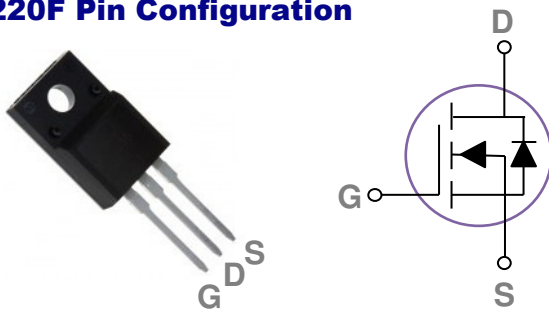


General Description

These N-Channel enhancement mode power field effect transistors are using super trench DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

TO220F Pin Configuration



BVDSS	RDSON	ID
100V	7.6mΩ	65A

Features

- 100V,65A, $R_{DS(ON)} = 7.6m\Omega @ V_{GS} = 10V$
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	+20 / -12	V
I_D	Drain Current – Continuous ($T_c=25^\circ C$)	65	A
	Drain Current – Continuous ($T_c=100^\circ C$)	41	A
I_{DM}	Drain Current – Pulsed ¹	260	A
EAS	Single Pulse Avalanche Energy ²	231	mJ
IAS	Single Pulse Avalanche Current ²	68	A
P_D	Power Dissipation ($T_c=25^\circ C$)	50	W
	Power Dissipation – Derate above $25^\circ C$	0.4	W/ $^\circ C$
T_{STG}	Storage Temperature Range	-50 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-50 to 150	$^\circ C$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	2.5	$^\circ C/W$

Electrical Characteristics (T_J=25 °C, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100	---	---	V
ΔBV _{DSS} /ΔT _J	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =1mA	---	0.049	---	V/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V , V _{GS} =0V , T _J =25°C	---	---	1	uA
		V _{DS} =80V , V _{GS} =0V , T _J =125°C	---	---	10	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =+20V , V _{DS} =0V	---	---	100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =18A	---	6.3	7.6	mΩ
		V _{GS} =4.5V , I _D =10A	---	8.8	11.4	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1	1.5	2.5	V
ΔV _{GS(th)}	V _{GS(th)} Temperature Coefficient		---	-5.5	---	mV/°C
gfs	Forward Transconductance	V _{DS} =10V , I _D =3A	---	15	---	S

Dynamic and switching Characteristics

Q _g	Total Gate Charge ^{3, 4}	V _{DS} =80V , V _{GS} =10V , I _D =10A	---	53.5	80	nC
Q _{gs}	Gate-Source Charge ^{3, 4}		---	7.5	12	
Q _{gd}	Gate-Drain Charge ^{3, 4}		---	13.3	20	
T _{d(on)}	Turn-On Delay Time ^{3, 4}	V _{DD} =50V , V _{GS} =10V , R _G =6Ω I _D =1A	---	14.6	30	ns
T _r	Rise Time ^{3, 4}		---	32.8	66	
T _{d(off)}	Turn-Off Delay Time ^{3, 4}		---	62.2	125	
T _f	Fall Time ^{3, 4}		---	28.4	56	
C _{iss}	Input Capacitance	V _{DS} =25V , V _{GS} =0V , F=1MHz	---	3250	6500	pF
C _{oss}	Output Capacitance		---	867	1730	
C _{rss}	Reverse Transfer Capacitance		---	58	116	
R _g	Gate resistance	V _{GS} =0V , V _{DS} =0V , F=1MHz	---	1.25	---	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V , Force Current	---	---	80	A
I _{SM}	Pulsed Source Current		---	---	160	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =1A , T _J =25°C	---	---	1	V
t _{rr}	Reverse Recovery Time	V _{GS} =0V , I _S =50A , di/dt=100A/μs	---	58	---	ns
Q _{rr}	Reverse Recovery Charge	T _J =25°C	---	85	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=50V, V_{GS}=10V, L=0.1mH, I_{AS}=68A., R_G=25Ω, Starting T_J=25°C.
3. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
4. Essentially independent of operating temperature.

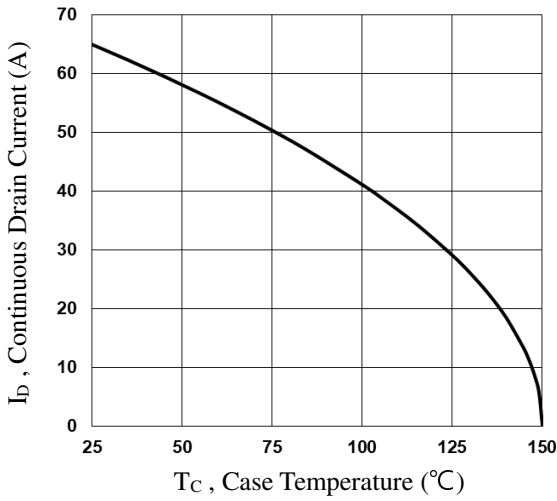


Fig.1 Continuous Drain Current vs. T_c

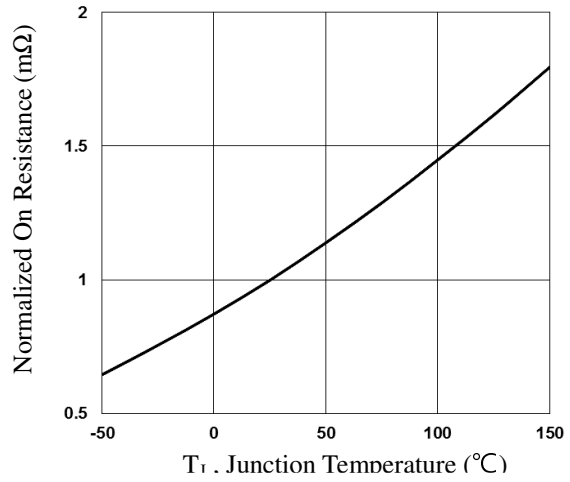


Fig.2 Normalized RDSON vs. T_j

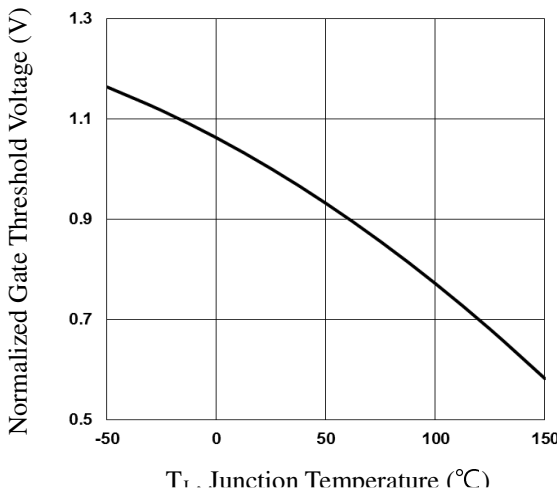


Fig.3 Normalized V_{th} vs. T_j

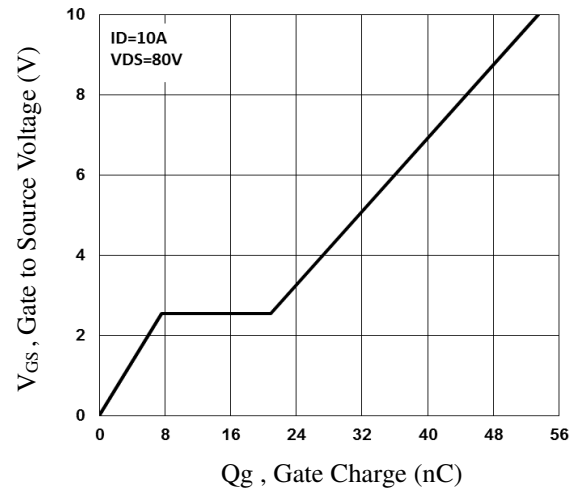


Fig.4 Gate Charge Characteristics

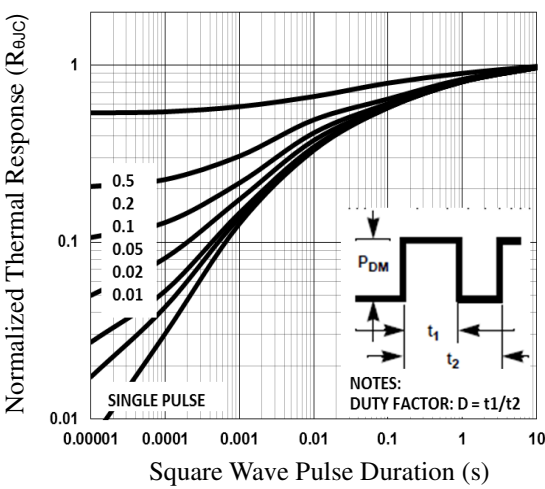


Fig.5 Normalized Transient Impedance

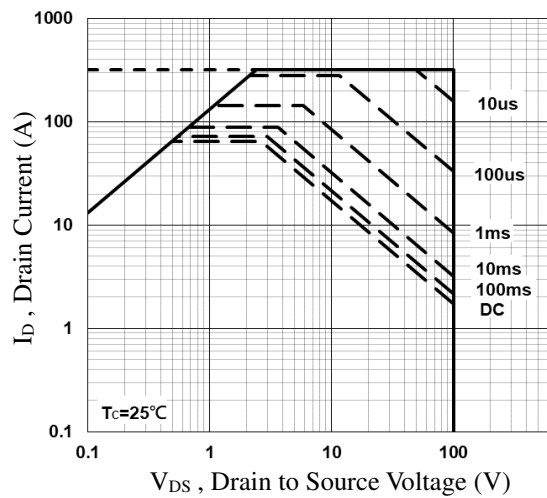


Fig.6 Maximum Safe Operation Area

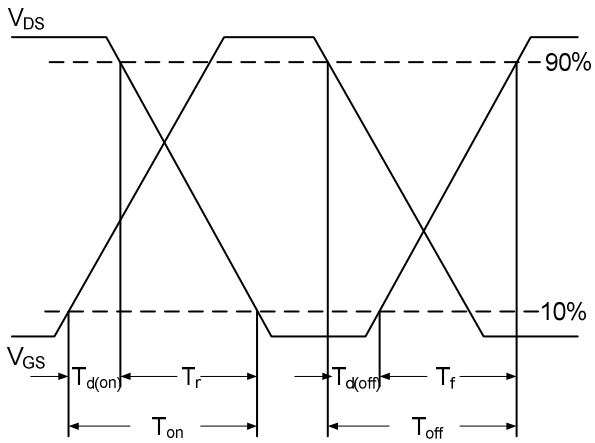


Fig.7 Switching Time Waveform

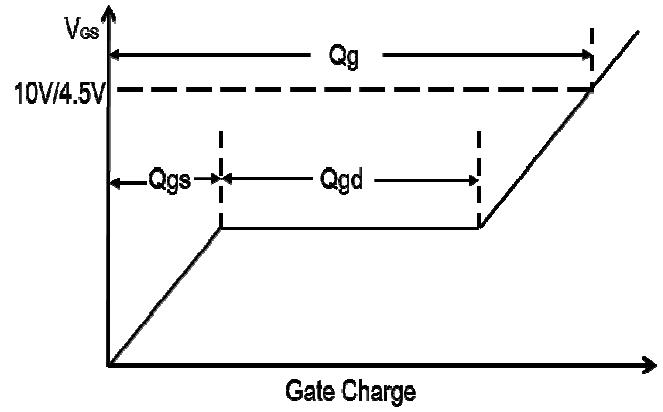
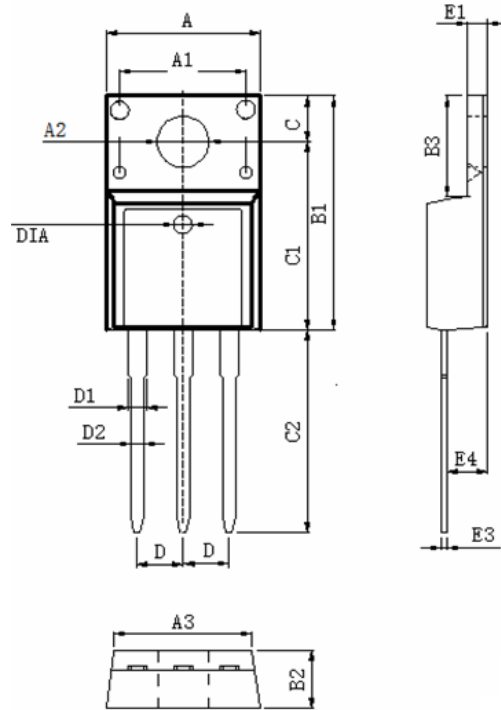


Fig.8 Gate Charge Waveform

TO220F PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	10.460	9.860	0.412	0.388
A1	7.100	6.900	0.280	0.272
A2	3.500	3.100	0.138	0.122
A3	9.900	9.500	0.390	0.374
B1	16.170	15.570	0.637	0.613
B2	4.900	4.500	0.193	0.177
B3	6.880	6.480	0.271	0.255
C	3.500	3.100	0.138	0.122
C1	12.870	12.270	0.507	0.483
C2	13.380	12.580	0.527	0.495
D	2.590	2.490	0.102	0.098
D1	1.470	1.070	0.058	0.042
D2	0.900	0.700	0.035	0.028
E1	2.740	2.340	0.108	0.092
E3	0.600	0.400	0.024	0.016
E4	2.960	2.560	0.117	0.101
DIA	Φ1.5 TYP.	deep0.1 TYP.	Φ0.059 TYP.	deep0.004 TYP.